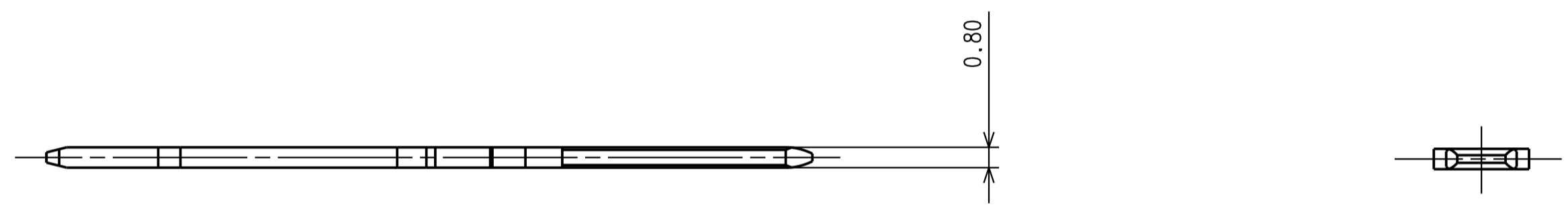
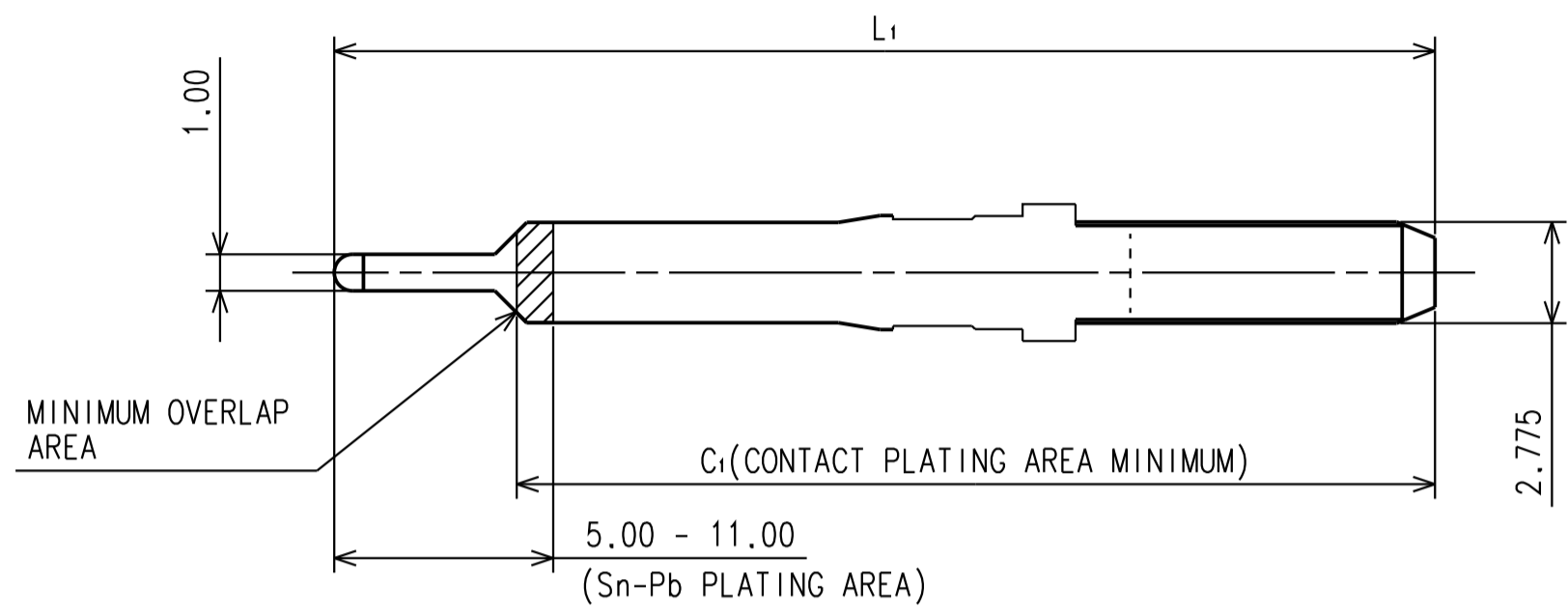


PART NUMBER	PART NAME	L ₁	C ₁	UNDERPLATING	CONTACT PLATING	SOLDER PLATING
7114-5945-02	2.8 KAIZEN CONNECTOR PCB TERMINAL	30.16	25.16	Cu (ALL OVER)	TIN REFLOW PLATING (AS SHOWN)	Sn-Pb SOLDER PLATING (AS SHOWN)



NOTES:

1. MATERIAL: UNS C26000, H04.
2. TERMINAL IS BENT AFTER PRESS FIT.
3. PLATING: SEE TABLE
4. ALL PLATING MUST BE ELECTRO-DEPOSITED.
5. PART MUST BE FREE OF SHARP EDGES AND BURRS THAT AFFECT FUNCTION.
6. PART TO COMPLY WITH YPES-31-038 REQUIREMENTS.

ISSUE MARK

LET	DATE	REVISION RECORD	NO.	CHKD
-	01-26-2012	NEW	C12-A019	MMR

GENERAL TOLERANCE							
	10 MAX	50 MAX	100 MAX	250 MAX	250 OVR	ANGLE	ECCENT
A	± 0.15	± 0.2	± 0.3	± 0.5	± 0.75	± 30'	0.1
B	± 0.2	± 0.3	± 0.55	± 0.95	± 1.4	± 30'	0.1
⊙	± 0.3	± 0.5	± 0.8	± 1.4	± 2	± 30'	0.15
SPECIFIED						MASS	(0.60 g)

CUSTOMER		CUSTOMER PART NO.		CUSTOMER DWG NO.	
OFFICE YNA		TRIAL PART NO.		VENDOR NO.	
DWG TYPE	DWG SOURCE	DWG DATE	UNIT	SCL	ANGLE
R	7114-5945-02:MA	01-26-2012	mm	5/1	3
APPROVED	CHECKED	CHECKED	DESIGN	DRAWN	
			R.	HOLCOMBE	
			12.11.03		

MATL. SPEC.	SEE NOTES	TREAT & FIN.	SEE NOTES
NAME 2.8 KAIZEN CONNECTOR PCB TERMINAL			
PART NO. 7114-5945-02 ETC.			
DWG NO. 7114-5945-02:R			SET DWG NO.
YAZAKI CORPORATION			

